

# UTC UNISONIC TECHNOLOGIES CO., LTD

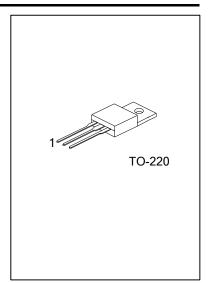
**7N75 Preliminary Power MOSFET** 

# 7.0A, 750V N-CHANNEL POWER MOSFET

### **DESCRIPTION**

The UTC 7N75 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specializes in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

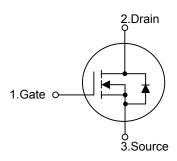
The UTC 7N75 is universally applied in high efficiency switch mode power supply.



### **FEATURES**

- \*  $R_{DS(on)}$ =1.7 $\Omega$  @  $V_{GS}$  =10V
- \* High switching speed
- \* Improved dv/dt capability
- \* 100% avalanche tested

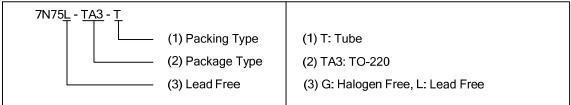
#### **SYMBOL**



#### ORDERING INFORMATION

Ordering Number		Daalaasa	Pin Assignment			Daaldaa	
Lead Free	Halogen Free	Package	1	2	3	Packing	
7N75L-TA3-T	7N75G-TA3-T	TO-220	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



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# ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	750	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Drain Current	Continuous	I <sub>D</sub>	7	Α
	Pulsed (Note 2)	I <sub>DM</sub>	28	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	530	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		$P_{D}$	142	W
Junction Temperature		TJ	150	°C
Storage Temperature		T <sub>STG</sub>	-55~+150	°C

- Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
  - 2. Repetitive Rating: Pulse width limited by maximum junction temperature
  - 3. L=19.5mH,  $I_{AS}$ =7A,  $V_{DD}$ = 50V,  $R_{G}$ =25 $\Omega$ , Starting  $T_{J}$ =25 $^{\circ}$ C
  - 4.  $I_{SD} \le 7A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25$ °C

# ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	S UNIT	
Junction to Ambient	$\theta_{JA}$	62.5	°C/W	
Junction to Case	$\theta_{JC}$	0.88	°C/W	

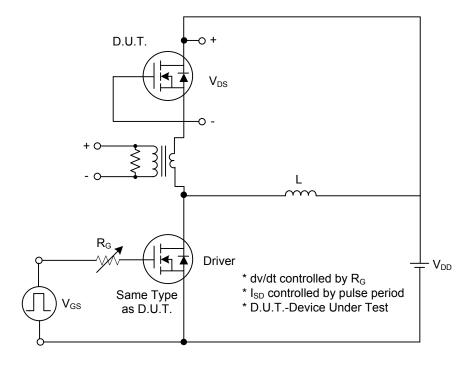
# ■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	750			V
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	I <sub>D</sub> =250μA,Referenced to 25°C		0.67		V/°C
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =750V, V <sub>GS</sub> =0V			1	μΑ
			V <sub>DS</sub> =600V, T <sub>C</sub> =125°C			1	μΑ
Gate-Source Leakage Current	Forward		$V_{DS}$ =0V , $V_{GS}$ =30V			100	nA
	Reverse	- I <sub>GSS</sub>	V <sub>DS</sub> =0V ,V <sub>GS</sub> =-30V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.0		4.0	V
Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS}$ =10V, $I_D$ =3.5A		1.35	1.7	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C <sub>ISS</sub>			1200	1600	pF
Output Capacitance		Coss	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=1.0MHz		150	190	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			18	25	pF
SWITCHING PARAMETERS				=.	=.		
Total Gate Charge		$Q_{G}$	\/ -000\/ \/ -10\/   -74		30		nC
Gate-Source Charge		$Q_GS$	V <sub>DS</sub> =600V, V <sub>GS</sub> =10V, I <sub>D</sub> =7A (Note 1,2)		6.5		nC
Gate-Drain Charge		$Q_GD$	(Note 1,2)		13		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			35	80	ns
Turn-ON Rise Time		t <sub>R</sub>	$V_{DD}$ =375V, $I_{D}$ =7A, $R_{G}$ =25 $\Omega$		79	165	ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	(Note 1,2)		80	160	ns
Turn-OFF Fall Time		t <sub>F</sub>			52	120	ns
SOURCE- DRAIN DIODE RATI	NGS AND CH	ARACTERIST	TICS	-	-		
Maximum Body-Diode Continuous Current		Is				7.0	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				28	Α
Drain-Source Diode Forward Voltage		$V_{SD}$	I <sub>S</sub> =7A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>RR</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =7A,		320		ns
Body Diode Reverse Recovery Charge		$Q_{RR}$	dl <sub>F</sub> /dt=100A/μs (Note 1)		2.4		μC

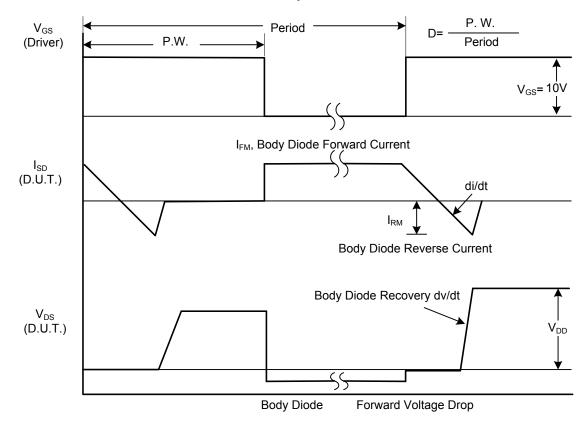
Note: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

<sup>2.</sup> Essentially independent of operating temperature

### TEST CIRCUITS AND WAVEFORMS

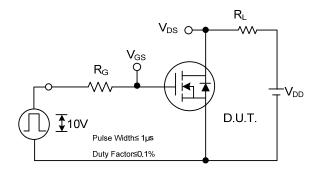


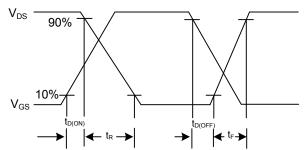
# Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

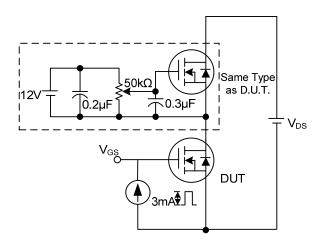
TEST CIRCUITS AND WAVEFORMS(Cont.)

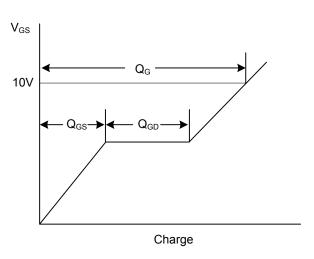




**Switching Test Circuit** 

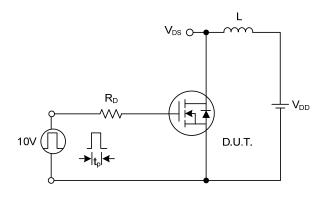
**Switching Waveforms** 

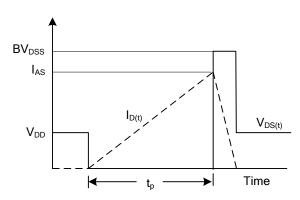




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

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